Please Amend Claims 1, 2, 5-11 and 13 as follows:

(Currently Amended) A magnetic head comprising:

 a first core having a thin film magnetic head; and
 a second core bonded to the first core from a surface whereon

the thin film magnetic head is formed,

a magnetic gap of the thin film magnetic head being exposed on a medium opposing surface of the first core and the second core,

wherein a bonding surface of at least one of the first core and the second core is provided with at least one abutting plane that juts out toward the other bonding surface and a groove formed to have a predetermined depth with a step provided between itselfthe groove and the abutting plane,

the abutting plane and the bonding surface of the other core are butted against each other,

an adhesion layer of a predetermined thickness is provided at least between the groove and the bonding surface of the other core, and the first core and the second core are bonded.

- 2. (Currently Amended) The magnetic head according to Claim 1, wherein the abutting plane is formed such that itthe abutting plane includes thea region formed on the first core wherein the thin film magnetic head is formed.
- 3. (Original) The magnetic head according to Claim 1, wherein the thickness of the adhesion layer ranges from 0.05 μ m to 0.3 μ m.
- 4. (Original) The magnetic head according to Claim 1, wherein the thin film magnetic head is constructed to have an MR thin film magnetic head.
- 5. (Currently Amended) The magnetic head according to Claim 1, wherein the thin film magnetic head and the first core are covered with a protective film made of an insulating material, and thea front surface of the protective film provides the bonding surface.

- 6. (Currently Amended) The magnetic head according to Claim 1, wherein the adhesion layer is formed of one of an epoxy-based adhesive agent erand a low-melting, glass-based adhesive agent.
- 7. (Currently Amended) A manufacturing method for a magnetic head comprising the steps of:
- (a) forming a plurality of thin film magnetic heads on a first substrate, then cutting the first substrate into a bar with a plurality of thin film magnetic heads aligned thereon in thea longitudinal direction to form a first bar;
 - (b) cutting a second substrate into a bar to form a second bar;
- (c) defining the surface of the first bar whereon the thin film magnetic heads are formed as thea surface to be bonded to the second bar, protuberantly forming at least one or more abutting planes on the bonding surface of at least one of the first bar or and the second bar at positions where they the abutting plane will remain in cores when the bars are cut into individual cores in a subsequent step, and forming a groove with a predetermined depth with a step provided between itself the groove and the abutting plane,
- (d) abutting the abutting plane formed on at least one bar against the bonding surface of the other bar, setting the bars in parallel to each other, and forming an adhesion layer of a predetermined thickness between the groove formed in at least one bar and the bonding surface of the other bar to bond the first bar and the second bar; and
- (e) cutting the first bar and the second bar into cores at between the individual thin film magnetic heads to produce a magnetic head having the first core and the second core bonded through the intermediary of the adhesion layer and a magnetic gap of the thin film magnetic head being exposed on the medium opposing surface of the first core and the second core.
- 8. (Currently Amended) The manufacturing method for a magnetic head according to Claim 7, wherein in the step (c), the abutting plane is

formed such that itthe abutting plane includes thea region wherein the thin film magnetic heads of the first bar are formed.

- 9. (Currently Amended) The manufacturing method for a magnetic head according to Claim 8, wherein in the step (c), the abutting plane is formed in each region wherein the thin film magnetic heads are formed, and the groove formed between the abutting planes is exposed up to thea front end surface of the first bar that will provide a medium opposing surface.
- 10. (Currently Amended) The manufacturing method for a magnetic head according to Claim 7, wherein in the step (c), the abutting planes are formed in thea region between the thin film magnetic heads arranged in the longitudinal direction of the first bar.
- 11. (Currently Amended) The manufacturing method for a magnetic head according to Claim 10, wherein the abutting planes formed between the thin film magnetic heads are dummy pads located on cutting lines for cutting the first bar and the second bar into cores in the step (e), and all orat least some of the dummy pads are removed by the cutting.
- 12. (Original) The manufacturing method for a magnetic head according to Claim 7, wherein the groove is formed to a depth ranging from 0.05 μ m to 0.3 μ m in the step (c) to form the adhesion layer to a thickness ranging from 0.05 μ m to 0.3 μ m in the step (d).
- 13. (Currently Amended) The manufacturing method for a magnetic head according to Claim 7, wherein <u>one of</u> an epoxy-based adhesive agent er<u>and</u> a low-melting, glass-based adhesive agent is selected as an adhesive agent in the step (d).